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Dated: August 26, 2010  
Electronic Signature for James E. Armstrong, IV: /James E. Armstrong, IV/

Docket No.: 80444(302768)  
(PATENT)

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of:  
Etsuo Okahara et al.

Application No.: 10/535,423

Confirmation No.: 6153

Filed: May 19, 2005

Art Unit: 1791

For: IN-MOLD COAT-FORMING METHOD AND  
IN-MOLD-COATED MOLD PRODUCT

Examiner: E. H. Lee

**AMENDMENT AFTER FINAL ACTION UNDER 37 C.F.R. 1.116**

MS AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir/Madam:

**INTRODUCTORY COMMENTS**

In response to the Office Action dated July 13, 2010, finally rejecting claims 1, 8 and 16-23, please amend the above-identified U.S. patent application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 5 of this paper.